

CEATEC JAPAN 2014 Special Exhibition NEXT Innovation Plaza Application Form

Application Deadline	May 30, 2014
Received	

As the authorized representative of my company/organization, I hereby submit this CEATEC JAPAN 2014 NEXT Innovation Plaza Application Form. Furthermore, I certify that the company/organization I represent will comply with all exhibition rules and regulations stipulated by both the CEATEC JAPAN Executive Board and the Japan Electronics Show Association.

■ Please check (☑) the type and fill in the number of booth desired, then select a rate and multiply to calculate the
total exhibition fee.
Note: Japan's consumption tax will be added to these fees at the rate applicable during CEATEC JAPAN 2014 (October 2014)

Во	oth configurati	No. applied f	Booth fee (excl. Consumption Tax)											
☐ 1-row booths (1, 2, 3, 4, 5, 6) ☐ 2-row booths (4, 6, 8, 10, 12) ☐ 3-row booths (9, 12, 15, 18) ☐ 4-row booths (16) ☐ Block booths (20, 25, 30, 35, 40, 45, 50, 55, 60, 65, 70, 75, 80, 85, 90, 95, 100)		Booths		 @ ¥360,000/booth (General corporate exhibitor, standard booth rate) @ ¥330,000/booth (CIAJ, JEITA, and CSAJ members, member booth rate) 					=	= Yen				
■ Please	check (☑) a	desired exhibition ca	tegory and fill i	n the	product	(s) pla	anne	d for	exhil	bit				
Category			•	☐ Robotics ☐ Healthcare ☐ Wearables ☐ Soft☐ Security & Surveillance ☐ Smartphone/Tablet Accessor									ent Oth	ers
	(s) planned exhibit													
	tion applicar	nt formation; data provided for o	cells marked with ◆ r	may be r	eflected or	n printec	d mate	erials a	nd/or o	fficial w	ebsite.			
(One le	of exhibitor etter per box, leav empty for space)	e												
Company representative	◆ Head offic address	е	iii	· ·	<u>'</u>	i i				<u> </u>	i	i	-i	-i
Comp	Title		Name (Last, First)											
Exhibition applicant	Address													
	Title/divisior	ı			Name (L	ast, Firs	st)							
	Telephone				Fa	ax								
	E-mail													
◆ W	ebsite URL													
◆ Applic Company	ant Details													
Job title	nume			Na	me (in pr	int)								
Signature					nen comp ase subm				ATEC	JAPAN	Manag	jement	Office	